## HIP2211EVAL2Z

User's Manual: Evaluation Board

Industrial Analog and Power

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## HIP2211EVAL2Z

## Evaluation Board

The HIP2211EVAL2Z evaluation board is designed to provide a quick and comprehensive method for evaluating the HIP2211 100V 3A source, 4A sink high-frequency half-bridge driver for driving the gates of two N -channel MOSFETs in a half-bridge configuration. Two N-channel MOSFETs (with dual footprint supporting multiple packages such as TO220 and DPAK) and an inductor-capacitor LC filter are included on the evaluation board to allow for the evaluation of a half-bridge driven load such as a synchronous buck switching regulator.

The HIP2211 half-bridge driver is offered in an 8 Ld SOIC, 8 Ld DFN, or 10 Ld DFN package (with enhanced thermal EPAD). The HIP2211EVAL2Z evaluation board is designed for the 8 Ld SOIC package. It operates from a supply voltage of 6 V to 18 V DC with the capability of driving both the high-side and the low-side MOSFETs in a 100V half-bridge configuration.

## Key Features

- 3A source and 4A sink NMOS gate drivers
- Internal level shifter and bootstrap diode for gate driver on high-side NFET
- Up to 100 V high-side bootstrap reference
- 6 V to 18 V bias supply operation
- Fast 15 ns typical propagation delay and 2 ns typical propagation delay match supports up to 1 MHz operation


## Specifications

This board is optimized for the following operating conditions:

- $V_{D D}$ supply: 12 V nominal
- VBRIDGE supply input: 0 V to 60 V
- PWM switching frequency: 100kHz
- Peak gate drive current: 3A source and 4A sink


## Ordering Information

| Part Number | Description |
| :--- | :--- |
| HIP2211EVAL2Z | HIP2211 8 Ld SOIC evaluation board |

## Related Literature

For a full list of related documents, visit our website:

- HIP2211, HIP2210 device pages


Figure 1. HIP2211 Typical Application Block Diagram

## 1. Functional Description

The HIP2211EVAL2Z is designed to provide a comprehensive and versatile platform for you to evaluate the functionality and prototype an application of the HIP2211 N-channel MOSFET half-bridge driver. This evaluation board includes the MOSFETs (with dual footprint for TO220 and DPAK) and an inductor-capacitor output filter for evaluating an open loop type synchronous buck DC/DC converter where the output voltage is controlled through the duty cycle of the signals into the $\mathrm{HI} / \mathrm{LI}$ pins.

### 1.1 Operating Range

The HIP2211EVAL2Z evaluation board is designed for 60V half-bridge applications with 12 V supply to bias the VDD of the HIP2211 IC. While the HIP2211 voltage ratings for the bootstrap reference and VDD supply are much higher, you should monitor the transient voltages at the switching nodes for applications exceeding 60V on the half-bridge or 12 V on the driver bias to ensure they do not violate the absolute maximum ratings of the HIP2211 driver.

The inductance and capacitance value of the output LC filter is chosen for 100 kHz switching operation. You can replace these components with different values if a different switching frequency is required.

### 1.2 Recommended Equipment

- A power supply that can deliver 12 V or higher with at least 2 A source current capability
- A power supply that can deliver 60V or higher to bias the half bridge
- A pulse generator with 0 V to 5 V logic level output and 100 kHz capability
- Optional: A pulse generator with two synchronizable 0 V to 5 V logic level outputs and 100 kHz capability
- A minimum 4-channel oscilloscope to monitor LI, HI, LO, HO, and HS signals
- Optional: A DC electronic load to draw current out of the LC filter output


### 1.3 Driver Logic Input

The HIP2211EVAL2Z evaluation board provides two options for the logic input of the driver (HI/LI or PWM) in an effort to relax the pulse generator requirement for evaluating the board.

If a pulse generator is used with only one square wave output available, connect it to the PWM terminal J1 on the board. This single PWM signal is converted into a HI signal and a LI signal with added RC delays.

Note: The HIP2211 HI and LI inputs do not have logic input lockout protection, so it is critical to provide adequate dead time between the two square wave inputs.

Before bringing up the HIP2211, adjust the RC delays (R3 and C 30 for the HI signal, R 2 and C 29 for the LI signal) and verify on the oscilloscope that the required duty cycle and input dead time are achieved. As an example, with a value of 3 k for $\mathrm{R} 2,4 \mathrm{k}$ for R3, and 100 pF for C 29 and C 30 , a 100 kHz PWM input with a $30 \%$ duty cycle is converted into the HI and LI signals with an approximately $25 \%$ duty cycle and $300 \mathrm{~ns}-350 \mathrm{~ns}$ dead time.

If two square wave outputs from a pulse generator are available, then simply connect them to the $\mathrm{HI}(\mathrm{J} 9)$ and LI (J13) terminals. Ensure that there are no jumpers on JP1, JP2, and JP3, because the PWM to HI/LI conversion circuit on the board is not required in this case. Adequate dead time is required between the two square wave inputs.


Figure 2. Dead Time

### 1.4 Quick Start Guide

1. Connect a 6 V to 18 V supply to VDD terminals on board $\{\mathrm{J} 2(+)$ and $\mathrm{J} 3(-)\}$.
2. If a pulse generator with only one square wave output is used, connect it to the PWM BNC connector J1. Note: There is a $50 \Omega$ pull-down resistor on this terminal; therefore, the output impedance of the signal generator should be set to $50 \Omega$ to match the pull-down resistor.)
a. Place a jumper on JP3 and remove any jumpers on JP1 and JP2 before turning on the VDD power supply.
b. Place oscilloscope probes on the converted HI and LI signals (the output of U 3 and U 2 , respectively).
c. Turn on the pulse generator and the VDD power supply. Adjust the RC delays (R3 and C30 for HI, R2 and C 29 for LI ) until the required input dead time and duty cycle are achieved.
d. Turn off the VDD power supply and the pulse generator output. Place a jumper on JP1 and JP2 and keep the jumper on JP3.
3. If a pulse generator with two square wave outputs is used, connect them to the $\mathrm{HI}(\mathrm{J} 9)$ and LI BNC (J13) connectors. Ensure that adequate dead time is set up between the two signals from the pulse generator.
4. Connect a power supply capable of 60 V or higher and 10 A to V_BRIDGE terminals $\{\mathrm{J} 18(+)$ and J17(-) \}.
5. Turn on the VDD power supply to 12 V .
6. Turn on the bridge voltage supply V_BRIDGE to the required voltage (such as 48V).
7. Turn on the PWM or the HI and LI signals. Verify HO and LO outputs are switching. LO switches between GND and VDD (12V for this example) in phase with LI. HO switches between GND and VHB + V_BDRIDGE in phase with HI.

## 2. PCB Layout Guidelines

For best thermal performance, connect the driver EPAD to a low thermal impedance ground plane. Use as many vias as possible to connect the top layer PCB thermal land to ground planes on other PCB layers. For best electrical performance, connect the VSS and AGND pins through the EPAD to maintain a low impedance connection between the two pins.

When adjustable dead time is used, connect the resistor to the RDT pin and GND plane close to the IC to minimize ground noise from disrupting the timing performance.

Place the VDD decoupling capacitors and bootstrap capacitors close to the VDD-VSS and HB-HS pins, respectively. Use decoupling capacitors to reduce the influence of parasitic inductors. To be effective, these capacitors must also have the shortest possible lead lengths. If vias are used, connect several paralleled vias to reduce the inductance.

In addition:

- Keep power loops as short as possible by paralleling the source and return traces
- Adding resistance might be necessary to dampen resonating parasitic circuits. In PCB designs with long leads on the LO and HO outputs, add series gate resistors on the bridge FETs to dampen the oscillations
- Large power components (such as power FETs, electrolytic capacitors, power resistors) have internal parasitic inductance, which cannot be eliminated. This must be accounted for in the PCB layout and circuit design
- If you simulate your circuits, consider including parasitic components


### 2.1 HIP2211EVAL2Z Evaluation Board



Figure 3. HIP2211EVAL2Z Evaluation Board (Top)


Figure 4. HIP2211EVAL2Z Evaluation Board (Bottom)


Figure 5. HIP2211EVAL2Z Schematic

### 2.3 Bill of Materials

| Qty | Reference Designator | Description | Manufacturer | Manufacturer Part |
| :---: | :---: | :---: | :---: | :---: |
| 1 |  | PWB-PCB, HIP2211EVAL2Z, REVA, ROHS | IMAGINEERING INC | HIP2211EVAL2ZREVAPCB |
| 2 | C5, C6 | CAP, SMD, 1210, 0.1 $\mu \mathrm{F}, 200 \mathrm{~V}, 20 \%, \mathrm{X} 7 \mathrm{R}$, ROHS | KEMET | C1210C104K2RAC |
| 1 | C12 | CAP, SMD, 2225, 1.0 F , 200V, 10\%, X7R, ROHS | KEMET | C2225C105K2RAC7800 |
| 1 | C34 | CAP, SMD, 0603, 10 F F, 10V, 20\%, X7R, ROHS | MURATA | GRM188Z71A106MA73D |
| 1 | C22 | CAP, SMD, 0805, 1.0 ${ }^{\text {F }}$, 50V, 10\%, X7R, ROHS | MURATA | GRM21BR71H105KA12L |
| 2 | C29, C30 | CAP, SMD, 0603, 100pF, 50V, 5\%, C0G, ROHS | PANASONIC | ECJ-1VC1H101J |
| 4 | C4, C31, C32, C33 | CAP, SMD, 0603, $0.1 \mu \mathrm{~F}, 50 \mathrm{~V}, 10 \%$, X7R, ROHS | AVX | 06035C104KAT2A |
| 1 | C2 | CAP, SMD, 0603, 0.22 $\mathrm{F}, 50 \mathrm{~V}, 10 \%$, X7R, ROHS | MURATA | GCM188R71H224KA64D (AEC-Q200) |
| 2 | C10, C11 | CAP, SMD, 0805, 0.1 $\mu \mathrm{F}, 100 \mathrm{~V}, 10 \%, \mathrm{X7R}$, ROHS | TDK | C2012X7R2A104K |
| 4 | C13, C14, C23, C24 | CAP, SMD, 1210, 1.0 $\mu \mathrm{F}, 100 \mathrm{~V}, 10 \%, \mathrm{X7R}$, ROHS | VENKEL | C1210X7R101-105KNE |
| 2 | C3, C21 | CAP, SMD, 1210, 4.7 ${ }^{\text {F }}$, 50V, 10\%, X7R, ROHS | MURATA | GRM32ER71H475KA88L |
| 2 | J2, J3 | CONN-TURRET, TERMINAL POST, TH, ROHS | KEYSTONE | 1514-2 |
| 3 | J1, J9, J13 | CONN-BNC, RECEPTACLE, TH, 4 POST, $50 \Omega$, SILVERCONTACT, ROHS | AMPHENOL | 31-5329-51RFX |
| 16 | TP1-TP11, TP14, TP15, TP16, TP18, TP19 | CONN-MINI TEST POINT, VERTICAL, WHITE, ROHS | KEYSTONE | 5002 |
| 6 | J4, J5, J6, JP1, JP2, JP3 | CONN-HEADER, 1x2, RETENTIVE, 2.54mm, 0.230x 0.120, ROHS" | BERG/FCI | 69190-202HLF |
| 2 | D2, D3 | DIODE-SWITCHING, AXIAL, DO-35, 100V, $0.2 \mathrm{~A}, 500 \mathrm{~mW}$, ROHS | FAIRCHILD | 1N4148 |
| 1 | L1 | COIL-INDUCTOR, AEC-Q200, SMD, 16.9mm, $6.8 \mu \mathrm{H}, 20 \%$, 19A, ROHS | BOURNS | SRP1770TA-6R8M |
| 1 | U1 | IC-100V, 4A HI/LI HALF BRIDGE DRIVER, 8P, SOIC, ROHS | RENESAS ELECTRONICS AMERICA | HIP2211FBZ |
| 1 | U4 | IC-40V LDO ADJ. LINEAR REGULATOR, 8P, EPSOIC, ROHS | INTERSIL | ISL80136IBEAJZ |
| 1 | U2 | IC-INVERTER, 1CHANNEL, SCHMITT TRIGGER, SMD, 5P, SC-70-5, ROHS | TEXAS INSTRUMENTS | SN74LVC1G14DCKT |
| 1 | U3 | IC-BUFFER, NON-INVERTING, SCHMITT TRIGGER, SMD, 5P, SC-70-5, ROHS | TEXAS INSTRUMENTS | SN74LVC1G17DCKR |
| 2 | Q1, Q2 | TRANSIST-MOS, N-CHANNEL, SMD, 3P, TO-252-3, 150V, 50A, ROHS | INFINEON TECHNOLOGY | IPD200N15N3GATMA1 |
| 2 | R2, R3 | POT-TRIM, TH, 3P, 50k, 1/4W, 10\%, 12TURN, TOPADJUST, ROHS | BOURNS | 3262W-1-503LF |
| 1 | R6 | RES, SMD, 0603, 0, 1/10W, TF, ROHS | VENKEL | CR0603-10W-000T |
| 2 | R15, R17 | RES, SMD, 0603, 100k, 1/10W, 1\%, TF, ROHS | VENKEL | CR0603-10W-1003FT |
| 1 | R7 | RES, SMD, 0603, 15k, 1/10W, 1\%, TF, ROHS | PANASONIC | ERJ-3EKF1502V |
| 1 | R8 | RES, SMD, 0603, 8.66k, 1/10W, 1\%, TF, ROHS | PANASONIC | ERJ-3EKF8661V |
| 2 | R4, R13 | RES, SMD, 0805, 3.3ת, 1/8W, 1\%, TF, ROHS | PANASONIC | ERJ-6RQF3R3V |
| 1 | R1 | RES, SMD, 2512, 49.9 , 1W, 1\%, TF, ROHS | VISHAY | CRCW251249R9FKEG (PbFREE) |


| Qty | Reference Designator | Description | Manufacturer | Manufacturer Part |
| :---: | :--- | :--- | :--- | :--- |
| 4 | J17, J18, J19, J20 | HDWARE, MTG, CABLE TERMINAL, <br> 6-14AWG, LUG\&SCREW, ROHS | BERG/FCI | KPA8CTP |
| 1 | C17 | CAP, SMD, $12.5 \times 16,100 \mu F, 100 \mathrm{~V}, 20 \%$, <br> ALUM.ELEC., ROHS | NICHICON | UUG2A101MNQ1MS |
| 2 | C15, C16 | CAP, SMD, $13.6 \mathrm{~mm}, 47 \mu F, 160 \mathrm{~V}, 20 \%$, <br> ALUM.ELEC., ROHS | NICHICON | UUG2C470MNL1MS |

### 2.4 Board Layout



Figure 6. Silkscreen Top Layer


Figure 7. Layer 1


Figure 8. Layer 2


Figure 9. Layer 3


Figure 10. Layer 4


Figure 11. Silkscreen Bottom Layer

## 3. Typical Performance Curves

$\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{BRIDGE}}=48 \mathrm{~V}, \mathrm{PWM}=100 \mathrm{kHz}$ square wave, 0 V to $5 \mathrm{~V}, 35 \%$ duty cycle, $\mathrm{R} 2=3.68 \mathrm{k}, \mathrm{R} 3=6.1 \mathrm{k}, \mathrm{C} 29=\mathrm{C} 30=100 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$


Figure 12. LO and HO when V_BRIDGE is off


Figure 13. Driving Half Bridge at 48V

## 4. Revision History

| Rev. | Date |  |
| :---: | :---: | :--- |
| 01.00 | Feb.11.20 | Initial release |

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